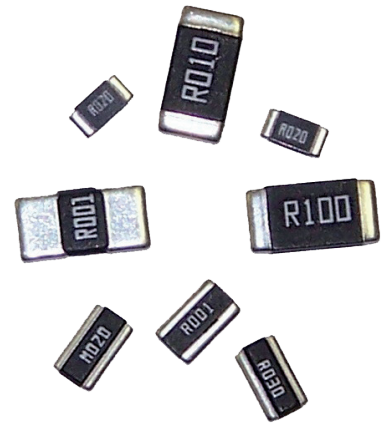


Low Resistance Metal Alloy Resistor

LRMA Series

- Resistance range 0.5mΩ to 500mΩ
- High temperature operation to 170°C
- Low thermal EMF version
- High power version
- Current sensing for power electronics
- RoHS compliant & halogen free
- AEC-Q200 qualified



All parts are Pb-free and comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

Electrical Data

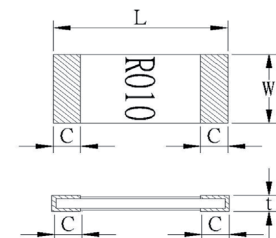
| LRMA Version | Size | T (Standard) | | P (Power) |
|-----------------------------------|--------|---------------------------|---|------------------------|
| | | 2010 | 2512 | 2512 |
| Power rating @70°C | W | 1.5 | ≤R01: 2, >R01: 1 | ≤R10: 3, >R10: 2 |
| Overload rating (5s) | W | 7.5 | ≤R01: 10, >R01: 5 | ≤R10: 15, >R10: 10 |
| Resistance range | mΩ | 5 to 100 | 1 to 100 | |
| Standard values ¹ | mΩ | 5, 6, 10, 15, 20, 50, 100 | 1, 1.5, 2, 3, 3.5, 4, 5, 6, 7, 8, 10, 11, 12, 15, 18, 20, 25, 30, 33, 35, 40, 50, 100 | |
| Resistance tolerance ¹ | % | 1, 5 | | |
| TCR (25 to 125°C) | ppm/°C | ≥R01: ±75 | >R001 & <R01: ±100, ≤R001: ±275 | <R001: ±200 ≥R001: ±50 |
| Ambient temperature | °C | -55 to 170 | | |
| Insulation resistance | MΩ | >100 | | |
| Element alloy | | Cu-Ni | | Cu-Ni / Mn-Cu |

| LRMA Version | Size | M (Low thermal EMF) | | | N (Inverse) | | |
|-----------------------------------|--------|---------------------------------|--|--|----------------|-----------------------------|------------------------------------|
| | | 0805 | 1206 | 2512 | 0612 | 0815 | 1225 |
| Power rating @70°C | W | 0.5 | 1 | ≤R01: 2, >R01: 1 | 1 ² | | 3 |
| Overload rating (5s) | W | 2.5 | 5 | ≤R01: 10, >R01: 5 | 5 | | 15 |
| Resistance range | mΩ | 2 to 25 | 1 to 50 | 0.5 to 60 | 1 to 3 | 3 to 30 | 2 to 40 |
| Standard values ¹ | mΩ | 1, 2, 3, 5, 6, 8, 9, 10, 20, 25 | 1, 1.2, 2, 3, 4, 5, 6, 7, 8, 9, 10, 12, 14, 15, 18, 20, 22, 25, 30, 39, 40, 50 | 0.5, 0.75, 1, 1.5, 2, 3.5, 5, 10, 20, 25, 30, 40, 50, 60 | 1, 3 | 3, 4, 5, 10, 15, 20, 25, 30 | 2, 3, 4, 5, 10, 15, 20, 25, 30, 40 |
| Resistance tolerance ¹ | % | 1, 5 | | | | | |
| TCR (25 to 125°C) | ppm/°C | ±100 | ±50 | ≥R01: ±75, >R001 & <R01: ±100 ≤R001: ±275 | ±100 | | |
| Ambient temperature | | -55 to 170°C | | | | | |
| Insulation resistance | MΩ | >100 | | | | | |
| Element alloy | | Mn-Cu | | | Mn-Cu / Cu-Ni | | |

Notes: 1. Non-standard values and tighter tolerances may be available for high volume requirements. 2. Requires 300mm² copper pad & trace area

Physical Data (All dimensions in mm and nominal weight in mg)

| Size | L | W | C | t | Wt |
|--|-----------|-----------|----------|------------|----------|
| 0805 | 2.0 ±0.1 | 1.25 ±0.1 | 0.4 ±0.2 | 0.6 ±0.2 | 5.5 |
| 0805 ≤R002 | | | 0.6 ±0.2 | | |
| 1206 <R002 | 3.2 ±0.2 | 1.6 ±0.2 | 1.1 ±0.3 | 0.75 ±0.2 | 18.3 |
| 1206 ≥R002 | | | 0.5 ±0.3 | | |
| 0612 | 1.7±0.2 | 3.2±0.2 | 0.4±0.2 | 0.6 ±0.2 | 12.9 |
| 0815 | 2.1 ±0.25 | 3.75 ±0.3 | 0.5 ±0.2 | 0.7 ±0.2 | 14.1 |
| 2010 | 5.0 ±0.2 | 2.5 ±0.2 | 0.6 ±0.3 | 0.6 ±0.2 | 35.6 |
| 2512 <R001 | 6.4 ±0.2 | 3.2 ±0.2 | 2.6 ±0.2 | 0.65 ±0.25 | 57 to 63 |
| 2512 ≥R001 & ≤R003 ¹ | | | 2.0 ±0.2 | | |
| 2512 >R003 ¹ | | | 0.9 ±0.2 | | |
| 1225 | 3.2 ±0.3 | 6.4 ±0.3 | 0.5 ±0.2 | 0.9 ±0.2 | 70 |



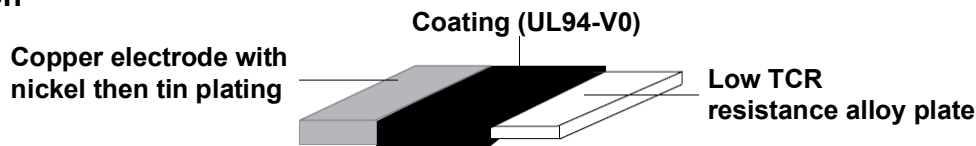
Note 1 - This applies to LRMA2512 and LRMA2512. For LRMA2512 this threshold is R004

General Note

TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

LRMA Series

Construction



Marking

The components are marked with ohmic value, e.g. "R002" = 2mΩ, "R010" = 10 mΩ. Due to space restrictions, for LRMAM1206-R001, "01" = 1mΩ is used, and for LRMAM0805, "2" = 2mΩ, "010" = 10 mΩ are used.

Solvent Resistance

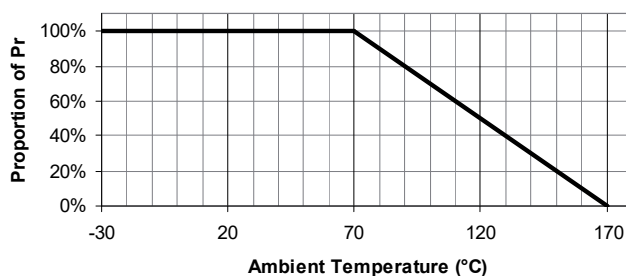
The component is resistant to all normal industrial cleaning solvents suitable for printed circuits.

Performance Data

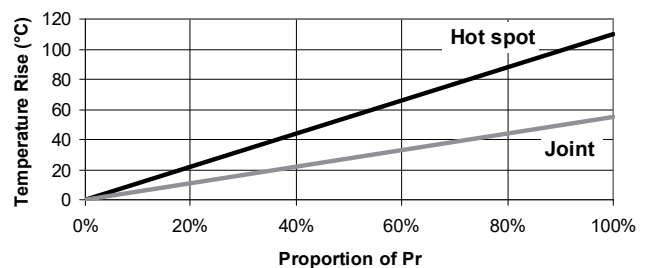
| | | Maximum (%) | Typical (%) |
|---|-----|----------------------|-------------|
| Load at rated power (cyclic load, 1000 hours at 70°C) | ±ΔR | 0805: 1.5 Others 1 | 0.3 |
| Short term overload (5 x rated power for 5s) | ±ΔR | 0.5 | 0.15 |
| Humidity (1000 hours, 85°C, 85%RH) | ±ΔR | 0805: 1 Others 0.5 | 0.15 |
| Temperature cycle (-40 to +125°C, 1000 cycles, 15 minute dwell) | ±ΔR | 0805: 1 Others 0.5 | 0.15 |
| Resistance to solder heat (260°C ±5°C for 20s ±1s) | ±ΔR | 0.5 | 0.3 |
| Solderability (245°C ±5°C for 2s ±0.5s) | | >95% coverage | |
| Dry heat (1000 hours at 170°C) | ±ΔR | 0805: 1.5 Others 0.5 | 0.3 |
| Low temperature storage (1000 hours at -55°C) | ±ΔR | 0.5 | 0.15 |
| Substrate bending (board 1.6mm, fulcrum spacing 90mm, deflection 2mm) | ±ΔR | 0805: 1 Others 0.5 | 0.3 |
| Insulation resistance (1 minute @ 100Vdc) | | >100M | |

Thermal Performance & Mounting

Temperature Derating

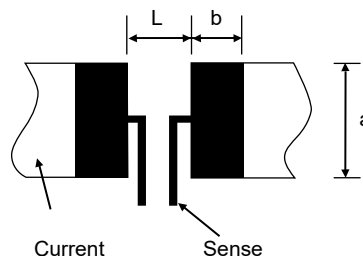


Typical Temperature Rise



Reference Pad Dimensions (mm)

| Size | a | b | L |
|-------------------------------|-----|------|-----|
| 0612 | 3.8 | 0.7 | 0.7 |
| 0805 | 1.4 | 1.15 | 1.2 |
| 1206 $\leq R002$ | 1.8 | 2.3 | 1.0 |
| 1206 $\geq R002$ | 1.8 | 1.7 | 1.6 |
| 0815 | 7.9 | 1.5 | 0.9 |
| 2010 | 3.4 | 1.5 | 3.5 |
| 2512 $\leq R003^1$ | 4.0 | 3.1 | 1.3 |
| 2512 $> R003^1$ | 4.0 | 2.1 | 4.1 |
| 1225 | 7.0 | 1.0 | 2.3 |



The temperature rise shown is highly dependent on mounting conditions. Reference conditions assume 20μ copper with thermal vias to multiple layers. The self-heating in the current tracks should be kept negligible, or allowed for by temperature derating.

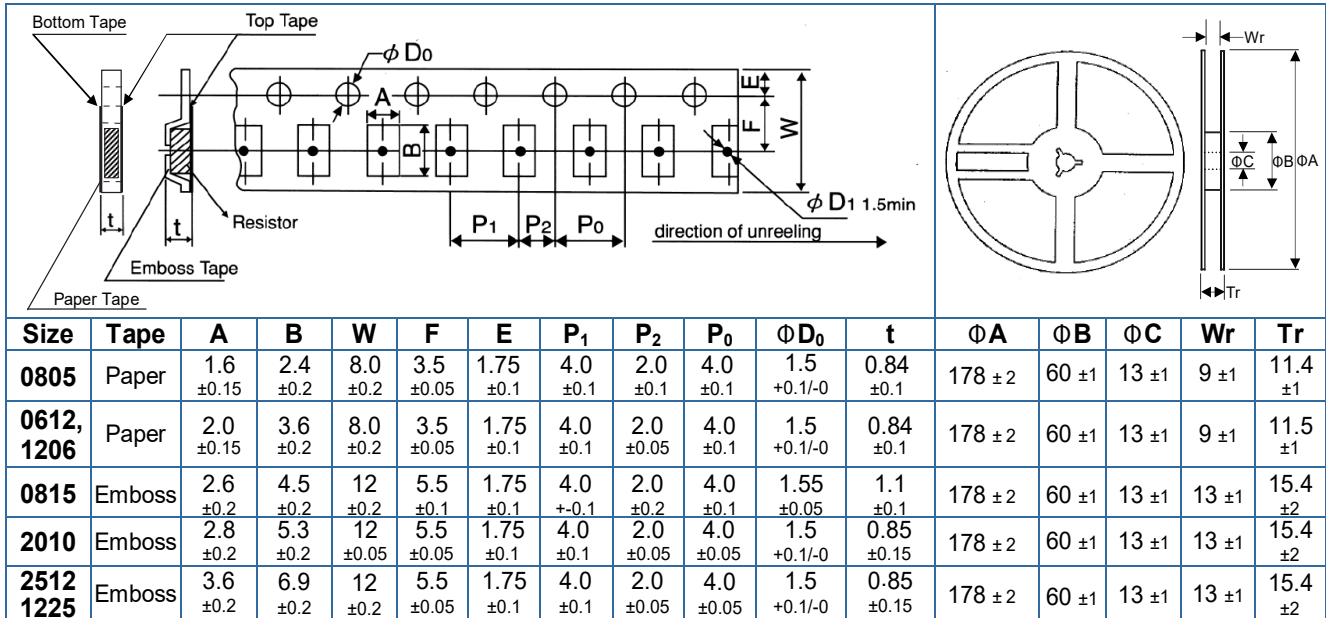
Note 1 - This applies to LRMAT2512 and LRMAM2512. For LRMAM2512 this threshold is R004

Standard 4-terminal probe pitches for measuring unmounted parts are 2.8 x 1.7mm (0612), 0.4 x 1.83mm (0805), 0.4 x 2.8mm (1206), 1.2 x 4.5mm (2010), 1.5 x 5.8mm (2512), and 5.4 x 3.4mm (1225). All probe location tolerances ±0.02mm.

General Note

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Packaging



Storage

Conditions: 5°C to 35°C and 40% to 75%RH
Shelf life: 2 years from manufacture

Processing

LRMA series resistors are suitable for both wave and IR reflow soldering. The recommended reflow profile for Pb-free SAC305 alloy (Sn 96.5%, Ag 3%, Cu 0.5%) soldering is as follows:

Pre-heat: 60s to 120s at 150°C to 180°C
Soldering: 20s to 40s at ≥230°C
Peak: 5s at 255°C to 260°C

Ordering Procedure

Example: LRMAM2512-R01FT4 (LRMA2512, low thermal EMF, 10 milliohms ±1%, Pb-free)



| 1 | 2 | 3 | 4 | 5 | 6 |
|------|-------------------|------|------------|-----------|-------------------------------------|
| Type | Version | Size | Value | Tolerance | Packing |
| LRMA | T Standard | 0612 | 3 to 6 | F = ±1% | Tape & reel |
| | P Power | 0805 | characters | J = ±5% | T5 0612, 0805, 1206 5000/reel |
| | M Low thermal EMF | 1206 | R = ohms | | T4 0815, 2010, 2512, 1225 4000/reel |
| | N Inverse | 0815 | | | |
| | | 2010 | | | |
| | | 2512 | | | |
| | | 1225 | | | |

Note 1: For values which require all 6 characters, e.g. R00075, the hyphen is omitted.

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